

این دیتاشیت توسط توکل الکترونیک تهیه و ارائه شده است.
جهت مشاهده قیمت، موجودی و ثبت سفارش این قطعه به وبسایت توکل الکترونیک مراجعه فرمایید.



مشاهده قیمت و خرید
برای خرید و مشاهده سایر محصولات کلیک کنید



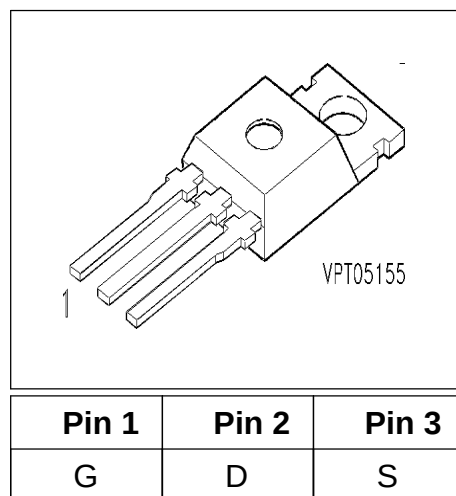
www.DataSheet4U.com

SIEMENS

BUZ 51

SIPMOS[®] Power Transistor

- N channel
- Enhancement mode
- Avalanche-rated



Type	V_{DS}	I_D	$R_{DS(on)}$	Package	Ordering Code
BUZ 51	1000 V	3.4 A	4 Ω	TO-220 AB	C67078-S1344-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current $T_C = 29^\circ\text{C}$	I_D	3.4	A
Pulsed drain current $T_C = 25^\circ\text{C}$	I_{Dpuls}	13.5	
Avalanche current, limited by T_{jmax}	I_{AR}	3.4	
Avalanche energy, periodic limited by T_{jmax}	E_{AR}	12	mJ
Avalanche energy, single pulse $I_D = 3.4\text{ A}$, $V_{DD} = 50\text{ V}$, $R_{GS} = 25\ \Omega$ $L = 67\text{ mH}$, $T_j = 25^\circ\text{C}$	E_{AS}	410	
Gate source voltage	V_{GS}	± 20	V
Power dissipation $T_C = 25^\circ\text{C}$	P_{tot}	125	W
Operating temperature	T_j	$-55 \dots + 150$	$^\circ\text{C}$
Storage temperature	T_{stg}	$-55 \dots + 150$	
Thermal resistance, chip case	R_{thJC}	≤ 1	K/W
Thermal resistance, chip to ambient	R_{thJA}	75	
DIN humidity category, DIN 40 040		E	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain- source breakdown voltage $V_{GS} = 0\text{ V}$, $I_D = 0.25\text{ mA}$, $T_j = 25\text{ }^{\circ}\text{C}$	$V_{(BR)DSS}$	1000	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}$, $I_D = 1\text{ mA}$	$V_{GS(th)}$	2.1	3	4	
Zero gate voltage drain current $V_{DS} = 1000\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 25\text{ }^{\circ}\text{C}$ $V_{DS} = 1000\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 125\text{ }^{\circ}\text{C}$	I_{DSS}	- -	0.1 10	1 100	μA
Gate-source leakage current $V_{GS} = 20\text{ V}$, $V_{DS} = 0\text{ V}$	I_{GSS}	-	10	100	nA
Drain-Source on-resistance $V_{GS} = 10\text{ V}$, $I_D = 2.2\text{ A}$	$R_{DS(on)}$	-	3.6	4	Ω

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Dynamic Characteristics

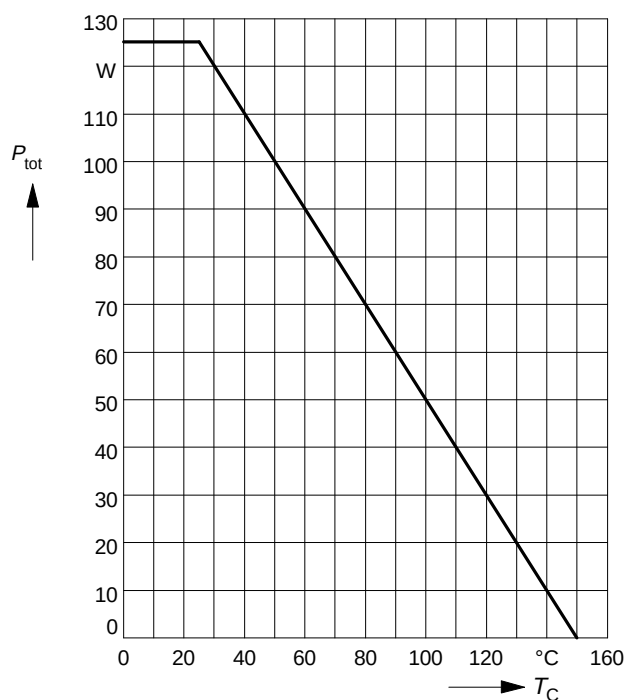
Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}$, $I_D = 2.2 \text{ A}$	g_{fs}	1	3	-	S
Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	980	1300	pF
Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	85	130	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	45	70	
Turn-on delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 2.1 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(on)}$	-	15	25	ns
Rise time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 2.1 \text{ A}$ $R_{GS} = 50 \Omega$	t_r	-	70	105	
Turn-off delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 2.1 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(off)}$	-	175	235	
Fall time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 2.1 \text{ A}$ $R_{GS} = 50 \Omega$	t_f	-	70	95	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Inverse diode continuous forward current $T_C = 25\text{ }^{\circ}\text{C}$	I_S	-	-	3.4	A
Inverse diode direct current,pulsed $T_C = 25\text{ }^{\circ}\text{C}$	I_{SM}	-	-	13.5	
Inverse diode forward voltage $V_{GS} = 0\text{ V}$, $I_F = 6.8\text{ A}$	V_{SD}	-	0.95	1.4	V
Reverse recovery time $V_R = 100\text{ V}$, $I_F = I_S$, $di_F/dt = 100\text{ A}/\mu\text{s}$	t_{rr}	-	0.3	-	μs
Reverse recovery charge $V_R = 100\text{ V}$, $I_F = I_S$, $di_F/dt = 100\text{ A}/\mu\text{s}$	Q_{rr}	-	2.5	-	μC

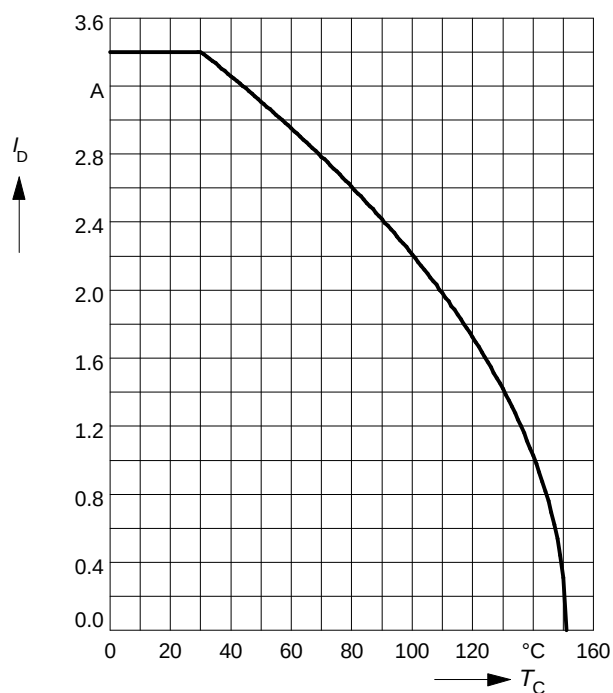
Power dissipation

$$P_{\text{tot}} = f(T_C)$$

**Drain current**

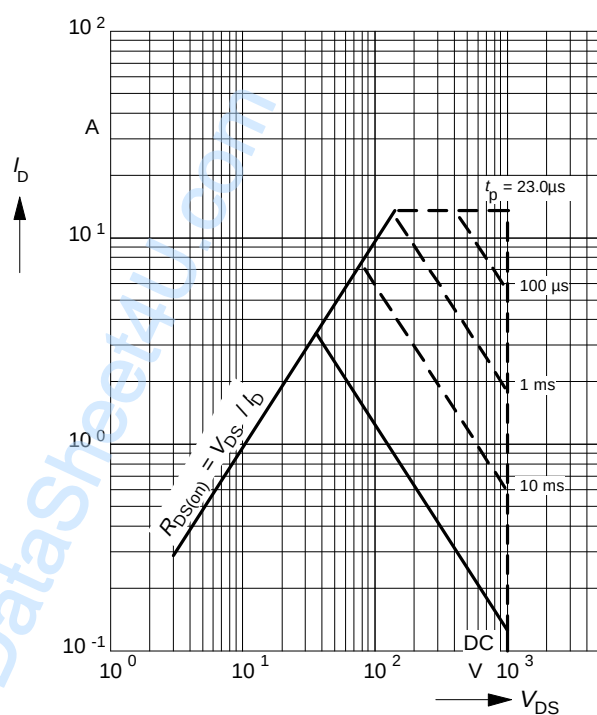
$$I_D = f(T_C)$$

parameter: $V_{GS} \geq 10 \text{ V}$

**Safe operating area**

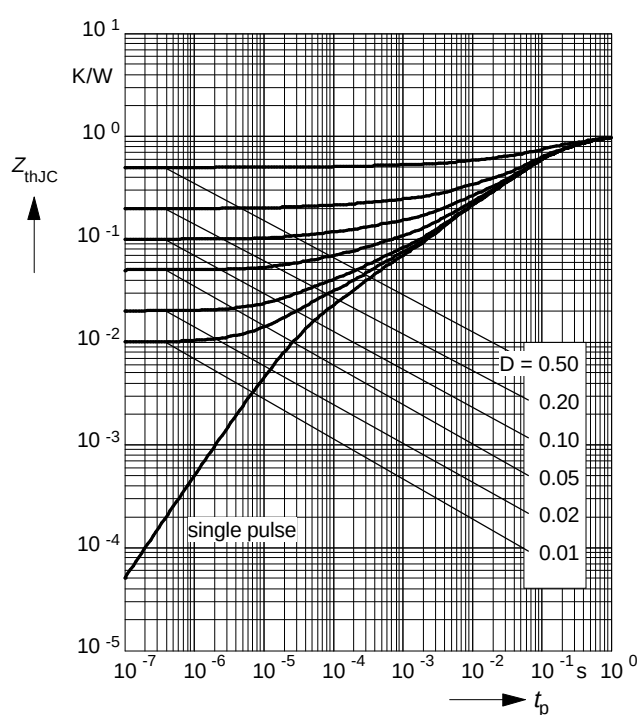
$$I_D = f(V_{DS})$$

parameter: $D = 0.01$, $T_C = 25^\circ\text{C}$

**Transient thermal impedance**

$$Z_{\text{th JC}} = f(t_p)$$

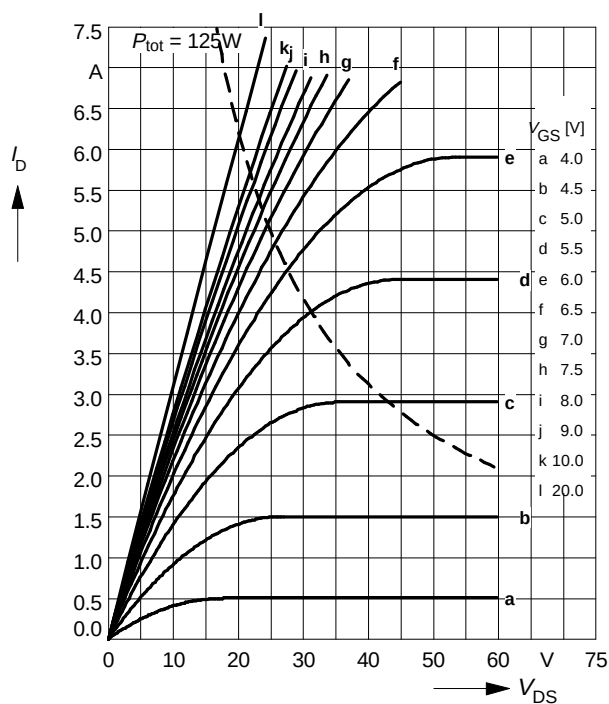
parameter: $D = t_p / T$



Typ. output characteristics

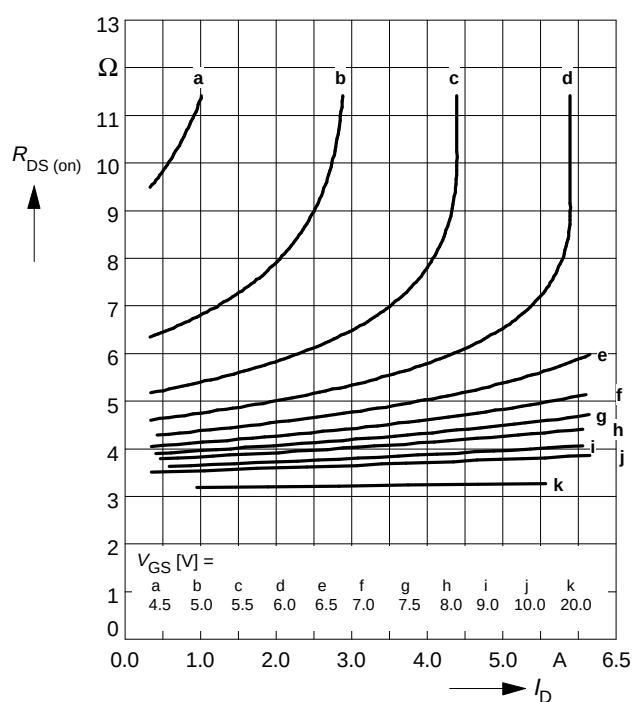
$$I_D = f(V_{DS})$$

parameter: $t_p = 80 \mu s$

**Typ. drain-source on-resistance**

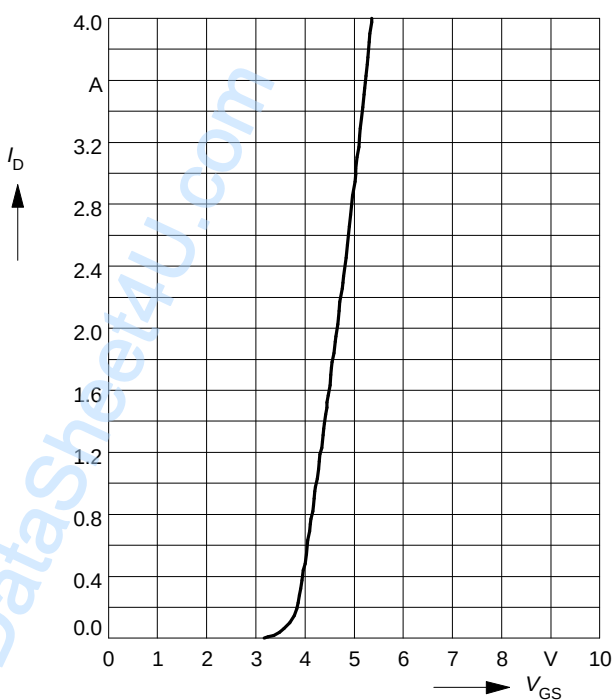
$$R_{DS(on)} = f(I_D)$$

parameter: V_{GS}

**Typ. transfer characteristics** $I_D = f(V_{GS})$

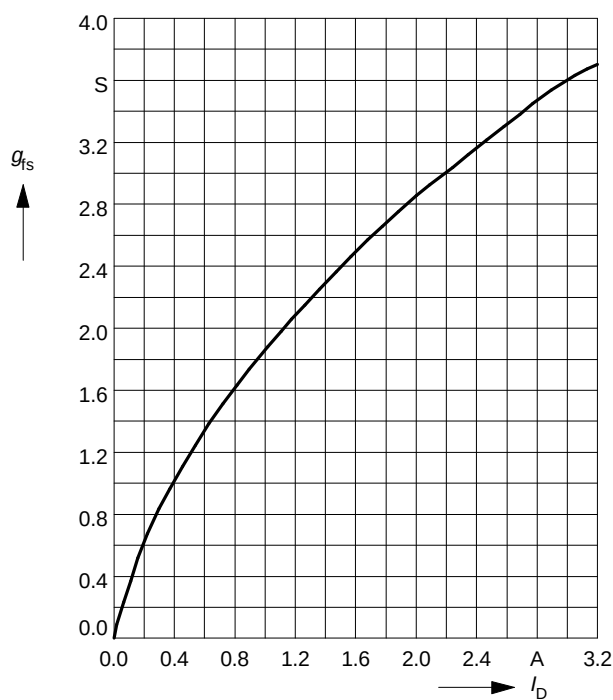
parameter: $t_p = 80 \mu s$

$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$

**Typ. forward transconductance** $g_{fs} = f(I_D)$

parameter: $t_p = 80 \mu s$,

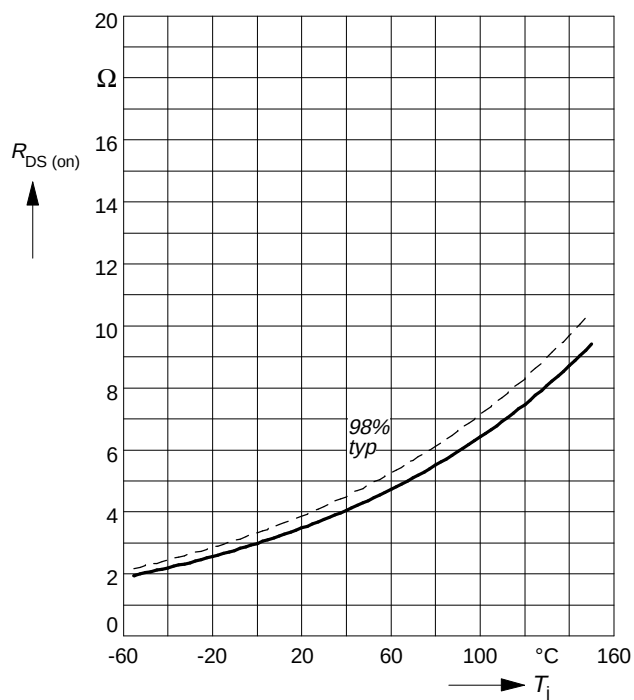
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



Drain-source on-resistance

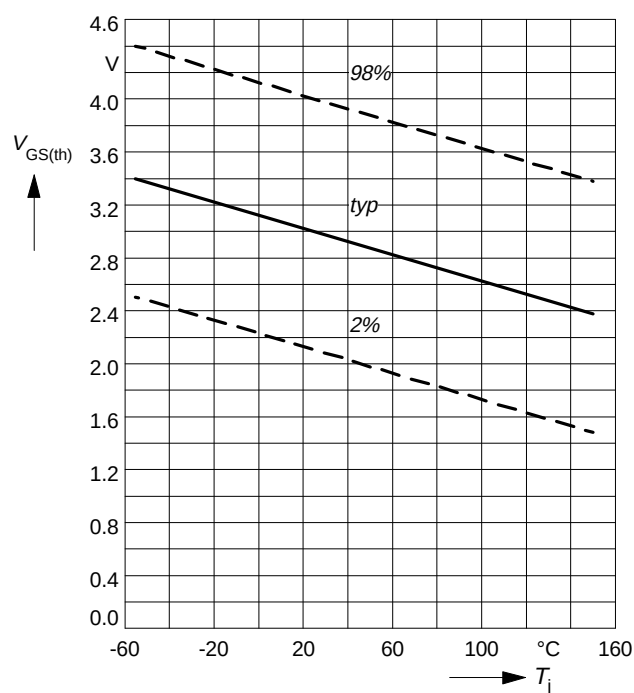
$$R_{DS(on)} = f(T_j)$$

parameter: $I_D = 2.2\text{ A}$, $V_{GS} = 10\text{ V}$

**Gate threshold voltage**

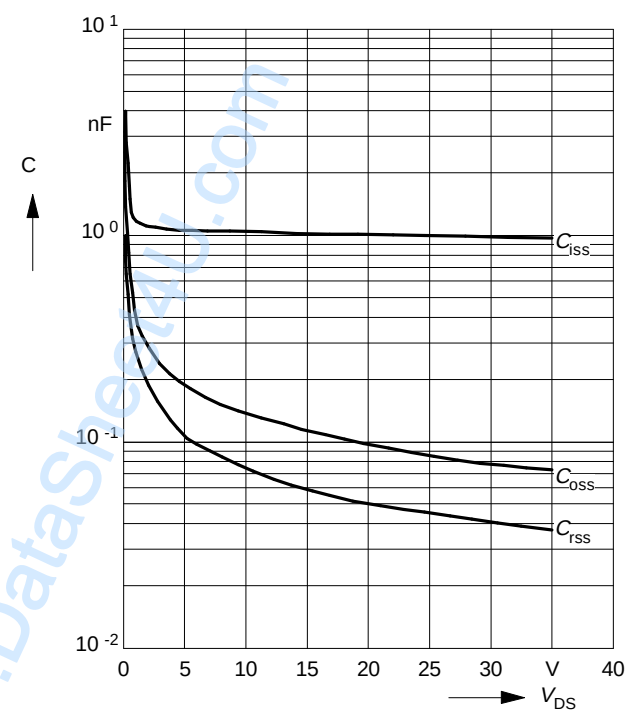
$$V_{GS(th)} = f(T_j)$$

parameter: $V_{GS} = V_{DS}$, $I_D = 1\text{ mA}$

**Typ. capacitances**

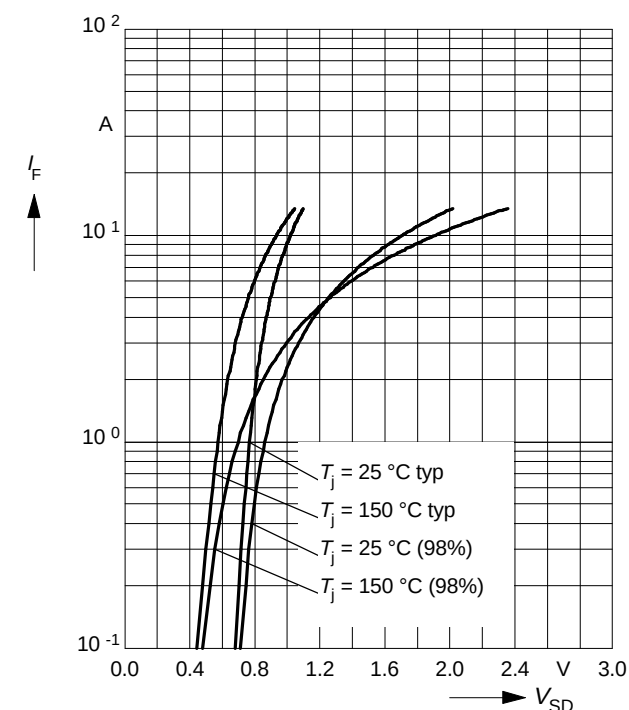
$$C = f(V_{DS})$$

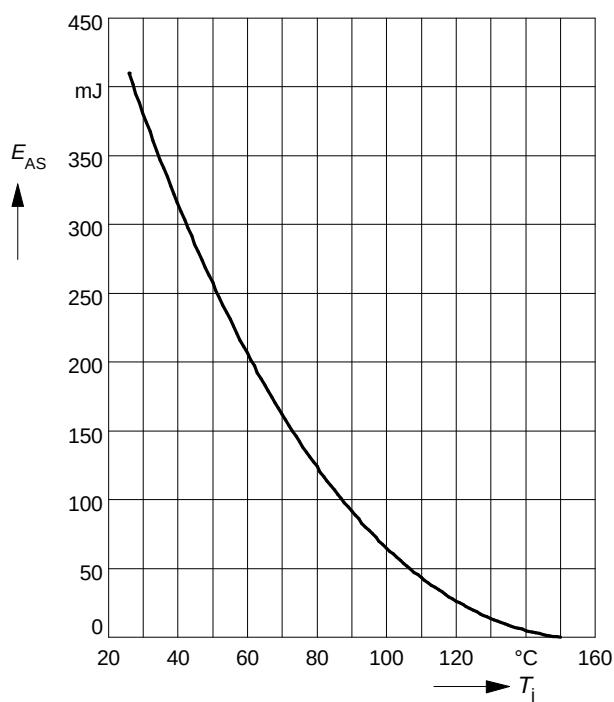
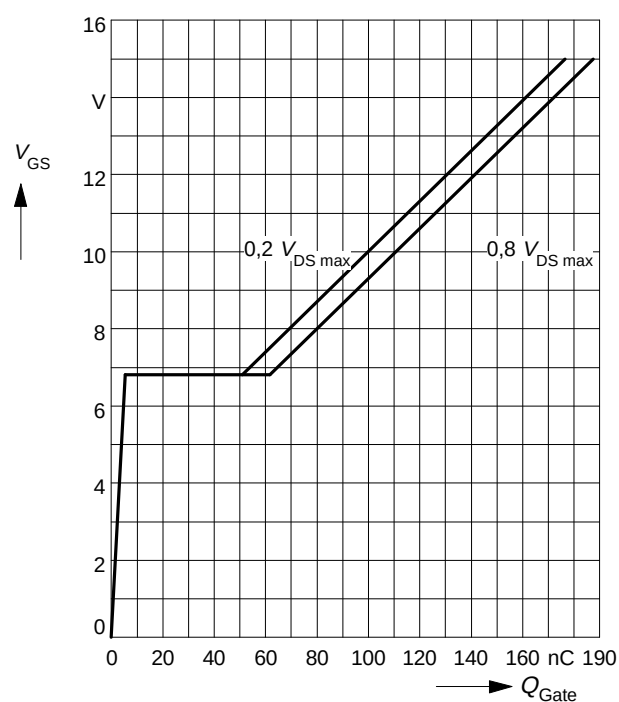
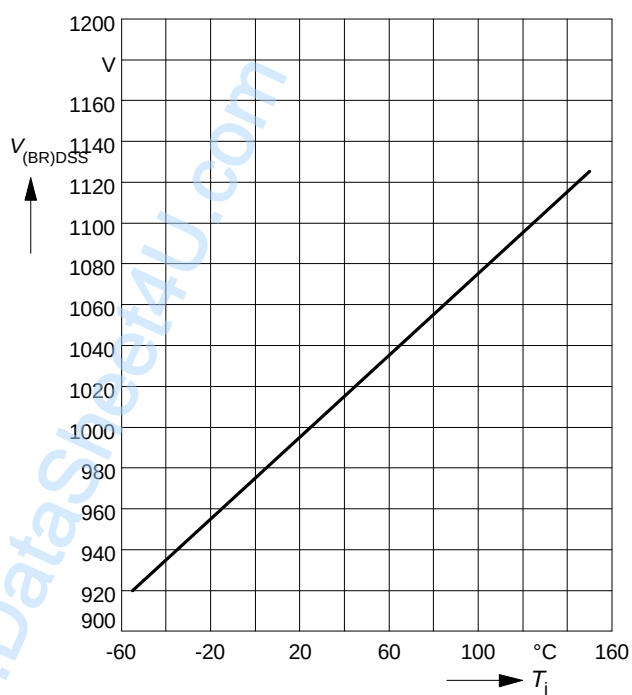
parameter: $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$

**Forward characteristics of reverse diode**

$$I_F = f(V_{SD})$$

parameter: T_j , $t_p = 80\text{ }\mu\text{s}$

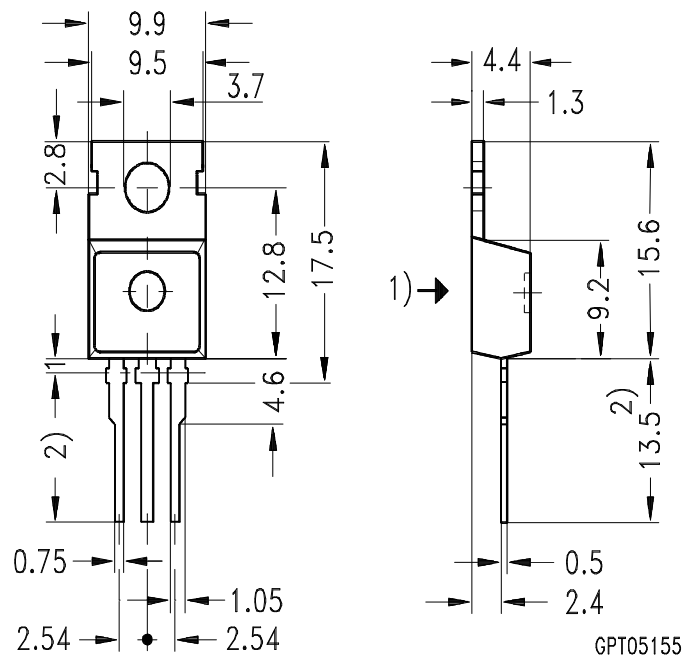


Avalanche energy $E_{AS} = f(T_j)$ parameter: $I_D = 3.4 \text{ A}$, $V_{DD} = 50 \text{ V}$ $R_{GS} = 25 \Omega$, $L = 67 \text{ mH}$ **Typ. gate charge** $V_{GS} = f(Q_{Gate})$ parameter: $I_{D \text{ puls}} = 5 \text{ A}$ **Drain-source breakdown voltage** $V_{(BR)DSS} = f(T_j)$ 

Package Outlines

TO-220 AB

Dimension in mm



1) punch direction, burr max. 0.04

2) dip tinning

3) max. 14.5 by dip tinning press burr max. 0.05